

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Seung H. Kang, *et al.*

Serial No.: 10/675,258

Filed: September 30, 2003

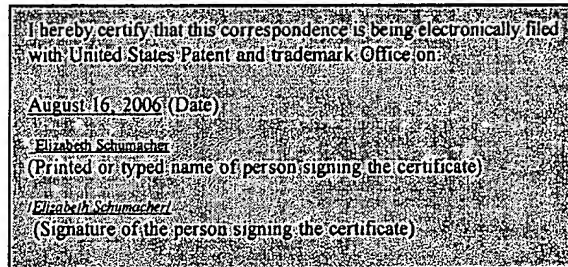
Title: ALUMINUM PAD POWER BUS AND SIGNAL ROUTING FOR
INTEGRATED CIRCUIT DEVICES UTILIZING COPPER
TECHNOLOGY INTERCONNECT STRUCTURES

Grp./A.U.: 2814

Examiner: Thao X. Le

Confirmation No.: 4017

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Sir:

AMENDMENT UNDER 37 C.F.R. § 1.116

In response to the Examiner's Action mailed June 21, 2006, please amend the above-identified application as follows:

P/s
Do
Not
Enter.
TL